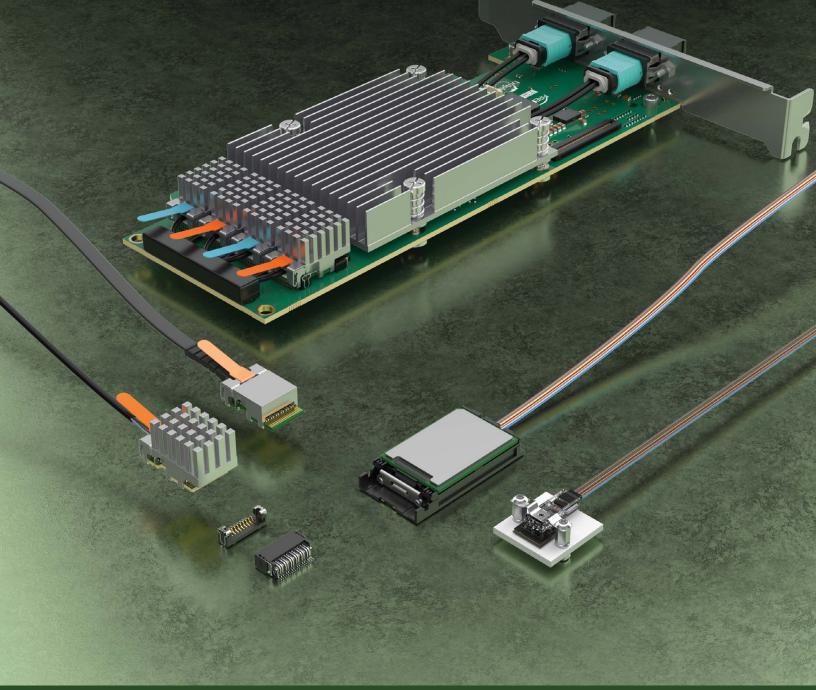


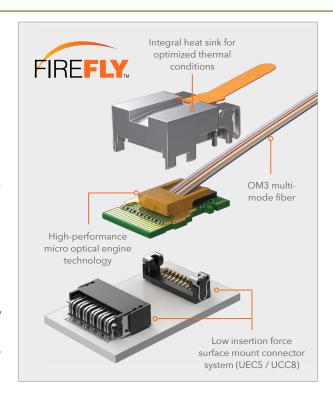
OPTICAL SOLUTIONS



ADVANCEDOPTICAL SYSTEMS

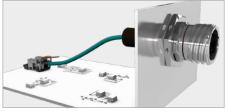
FIREFLY™ MICRO FLYOVER SYSTEM™ samtec.com/firefly

- Designed for flexibility, optical (ECUO) for greater distances and copper (ECUE) for cost optimization
- Industry leading miniature footprint allows for higher density close to the data source
- x4 and x12 configurations
- PCle®-Over-Fiber supports 3.0/4.0 data rates for low latency, power savings and guaranteed transmission
- -40 °C to +85 °C extended temperature system (ETUO) for military, aerospace and industrial applications
- Extreme Environment FireFly[™] sealed and parylene-coated for exposed applications (ETMO)
- Supports data center, HPC and FPGA protocols, including Ethernet, InfiniBand™, Fibre Channel, Aurora and PCle®
- Multiple end options available: MTP[®], MXC[®], MT, Glenair[®] Series 79,
 VITA 66.X and other common interfaces
- Development Kit available, visit samtec.com/kits





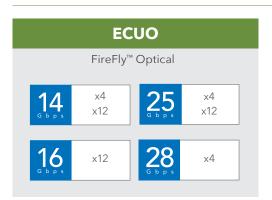
PCle*-Over-Fiber Adaptor Card (PCOA), available in x4, x8 or x16 configurations; supports 3.0/4.0 platforms and transparent or non-transparent bridging

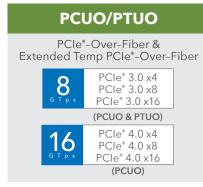


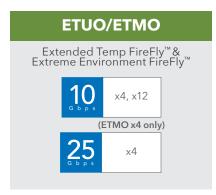
Extended Temp FireFly™ (ETUO) with Amphenol® Aerospace's bulkhead interconnects (MT38999) for rugged optical solutions



Glenair® Series 79 MT connector is an End 2 option featuring a miniature form factor and shielding; ideal for mil/aero and industrial applications







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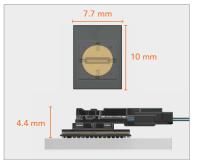


FIREHAWK™ RUGGEDIZED OPTICAL TRANSCEIVERS

samtec.com/firehawk

- Chip Scale Package (CSP) with the industry's smallest footprint and lowest profile, weighing less than 0.4 grams
- FireHawk[™] for Mil/Aero with an integrated microcontroller to automate key functions (CSPO)
- FireHawk[™] for Space designed to withstand the impacts of radiation without the need for a microcontroller (CSSO)
- Extreme performance with up to 40 Gbps aggregate transfer rate
- 10G x 4 data rate (10 Mbps to 10 Gbps per channel)
- Rugged BGA board attach withstands high shock and vibration
- -40 °C to +85 °C extreme temperature range (+95 °C available)
- RVCON® optical cables are removable and replaceable for repair or reconfiguration
- Development Kit available, visit samtec.com/kits
- Roadmap: 25G x 4 system (up to 25 Gbps per channel) in the same 10G connector footprint

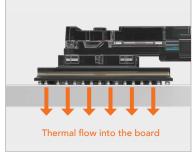




Ultra-compact, SWaP-optimized (Size, Weight and Power)



SMT reflow solderable with standard pick-and-place pad

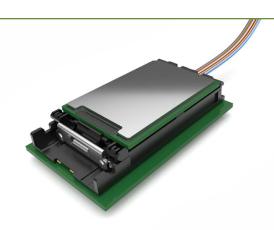


Direct mount to the PCB provides shortest possible thermal path



HALO™ NEXT GEN OPTICAL

- Capable of up to 112 Gbps PAM4 per lane
- Up to 16 channels (8 channel bidirectional)
- Low 6 mm profile with a 2-piece contact system
- Designed to withstand high shock and vibration
- Features a low center of gravity for a stable connection to the board
- Optically pluggable for easy replacement and increased uptime



OPTICS EVALUATION & DEVELOPMENT KITS



From concept and prototype to development and production, Samtec-designed and Partner-designed kits and boards featuring FireFly[™] and FireHawk[™] simplify design and reduce time to market. For more information, please visit samtec.com/kits or contact KitsAndBoards@samtec.com.

28 Gbps FireFly™ Evaluation Kit

Samtec's 28 Gbps FireFly[™] Evaluation Kit offers an easy-to-use platform for testing and real-time evaluation of the FireFly[™] Micro Flyover System[™]. The kit supports copper or optical FireFly[™] in x4 or x12 configurations.

(Samtec P/N: REF-209623-01)



14 Gbps FireFly™ FMC Development Kit

Samtec's 14 Gbps FireFly™ FMC Development Kit is VITA 57.1 electrically compliant and provides up to 140 Gbps full-duplex bandwidth over 10 channels from an FPGA to an industry-standard multi-mode fiber optic cable.

(Samtec P/N: REF-193429-01)

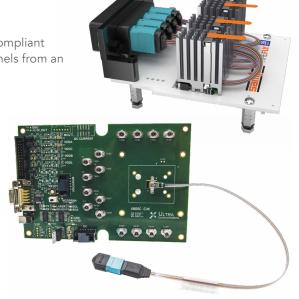
25/28 Gbps FireFly™ FMC+ Development Kit

Samtec's 25/28 Gbps FireFly $^{\text{TM}}$ FMC+ Module is VITA 57.4 electrically compliant and provides up to 400/448 Gbps full-duplex bandwidth over 16 channels from an FPGA to an industry-standard multi-mode fiber optic cable.

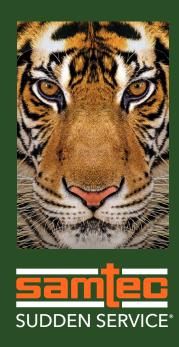
(Samtec P/N: REF-200772-XXX-XX-01)



Samtec's FireHawk™ Evaluation Kits offer real-time evaluation of FireHawk™ rugged optical transceivers in a lab or benchtop setting. Rated to 10 Gbps per lane in a x4 configuration, the transceivers combine extreme density with extreme performance to meet the harshest environments.



| KIT NAME | SAMTEC KIT PN | ULTRA COMMUNICATIONS KIT PN | APPLICATIONS |
|---------------------------------------|---------------|-----------------------------|--------------|
| FireHawk™ CSSO 10 Gbps Evaluation Kit | REF-230448-01 | X80S-0103-EVK-003 | Space |
| FireHawk™ CSPO 10 Gbps Evaluation Kit | REF-230449-01 | X80SC-0102-EVK-003 | Mil/Aero |



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